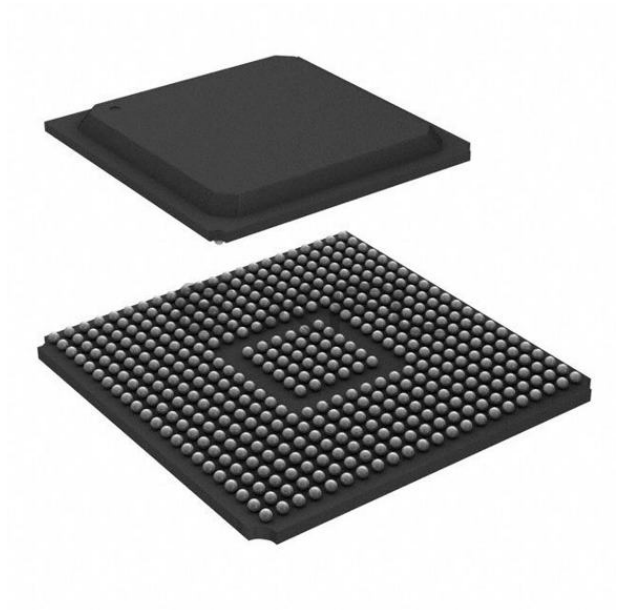

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	752
Number of Logic Elements/Cells	6768
Total RAM Bits	516096
Number of I/O	248
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp4-5fg456c

Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Functional Description

DS083 (v5.0) June 21, 2011 **Product Specification**

Virtex-II Pro[1] Array Functional Description

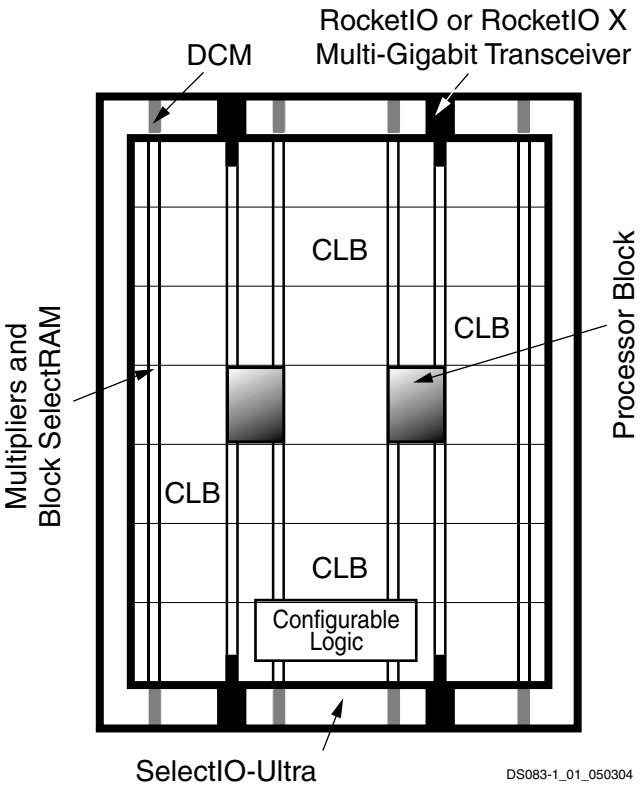

Figure 1: **Virtex-II Pro Generic Architecture Overview**

This module describes the following Virtex™-II Pro functional components, as shown in Figure 1:

- Embedded RocketIO™ (up to 3.125 Gb/s) or RocketIO X (up to 6.25 Gb/s) Multi-Gigabit Transceivers (MGTs)
- Processor blocks with embedded IBM PowerPC™ 405 RISC CPU core (PPC405) and integration circuitry.
- FPGA fabric based on Virtex-II architecture.

Virtex-II Pro User Guides

Virtex-II Pro User Guides cover theory of operation in more detail, and include implementation details, primitives and attributes, command/instruction sets, and many HDL code examples where appropriate. All parameter specifications are given only in Module 3 of this Data Sheet.

These User Guides are available:

- For detailed descriptions of PPC405 embedded core programming models and internal core operations, see **PowerPC Processor Reference Guide** and **PowerPC 405 Processor Block Reference Guide**.
- For detailed RocketIO transceiver digital/analog design considerations, see **RocketIO Transceiver User Guide**.
- For detailed RocketIO X transceiver digital/analog design considerations, see **RocketIO X Transceiver User Guide**,
- For detailed descriptions of the FPGA fabric (CLB, IOB, DCM, etc.), see **Virtex-II Pro Platform FPGA User Guide**.

All of the documents above, as well as a complete listing and description of Xilinx-developed Intellectual Property cores for Virtex-II Pro, are available on the Xilinx website.

Contents of This Module

- Functional Description: RocketIO X Multi-Gigabit Transceiver (MGT)
- Functional Description: RocketIO Multi-Gigabit Transceiver (MGT)
- Functional Description: Processor Block
- Functional Description: Embedded PowerPC 405 Core
- Functional Description: FPGA
- Revision History

Virtex-II Pro Compared to Virtex-II Devices

Virtex-II Pro devices are built on the Virtex-II FPGA architecture. Most FPGA features are identical to Virtex-II devices. Major differences are described below:

- The Virtex-II Pro FPGA family is the first to incorporate embedded PPC405 and RocketIO/RocketIO X cores.
- V_{CCAUX}, the auxiliary supply voltage, is 2.5V instead of 3.3V as for Virtex-II devices. Advanced processing at 0.13 µm has resulted in a smaller die, faster speed, and lower power consumption.
- Virtex-II Pro devices are neither bitstream-compatible nor pin-compatible with Virtex-II devices. However, Virtex-II designs can be compiled into Virtex-II Pro devices.
- On-chip input LVDS differential termination is available.
- SSTL3, AGP-2X/AGP, LVPECL_33, LVDS_33, and LVDSEXT_33 standards are not supported.
- The open-drain output pin TDO does not have an internal pull-up resistor.

1. Unless otherwise noted, "Virtex-II Pro" refers to members of the Virtex-II Pro and/or Virtex-II Pro X families.

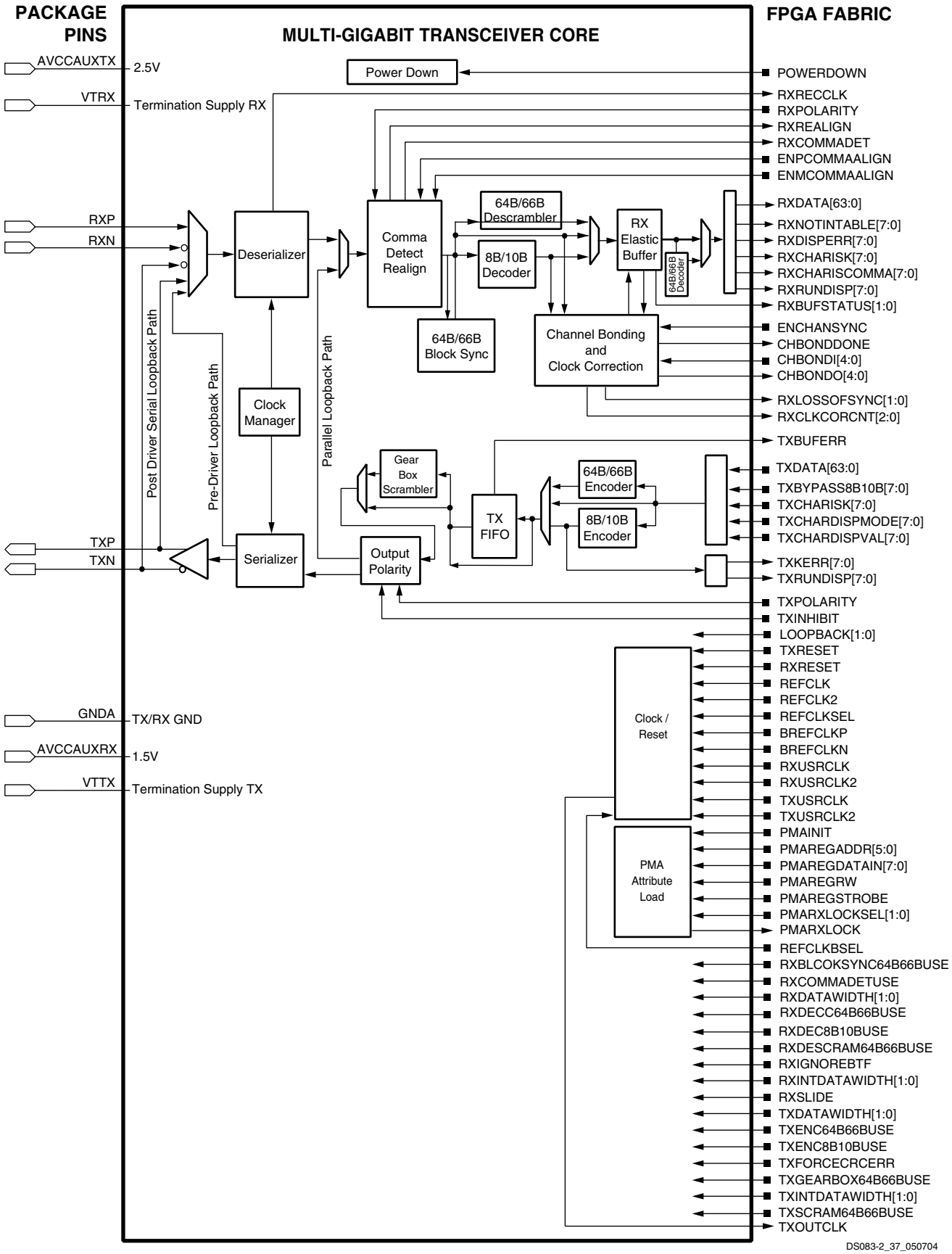

Figure 4: **RocketIO X Transceiver Block Diagram**

The Trace port provides instruction execution trace information to an external trace tool. The PPC405 core is capable of back trace and forward trace. Back trace is the tracing of instructions prior to a debug event while forward trace is the tracing of instructions after a debug event.

The processor JTAG port and the FPGA JTAG port can be accessed independently, or the two can be programmatically linked together and accessed via the dedicated FPGA JTAG pins.

For detailed information on the PPC405 JTAG interface, please refer to the "JTAG Interface" section of the **PowerPC 405 Processor Block Reference Guide**

CoreConnect™ Bus Architecture

The Processor Block is compatible with the CoreConnect™ bus architecture. Any CoreConnect compliant cores including Xilinx soft IP can integrate with the Processor Block through this high-performance bus architecture implemented on FPGA fabric.

The CoreConnect architecture provides three buses for interconnecting Processor Blocks, Xilinx soft IP, third party IP, and custom logic, as shown in Figure 15:

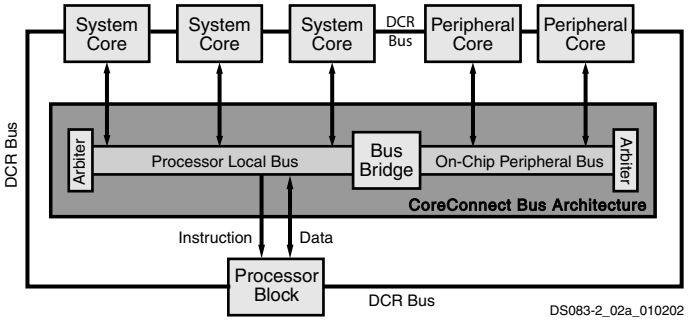

Figure 15: **CoreConnect Block Diagram**

- Processor Local Bus (PLB)
- On-Chip Peripheral Bus (OPB)
- Device Control Register (DCR) bus

High-performance peripherals connect to the high-bandwidth, low-latency PLB. Slower peripheral cores connect to the OPB, which reduces traffic on the PLB, resulting in greater overall system performance.

For more information, refer to:
http://www-3.ibm.com/chips/techlib/techlib.nfs/productfamilies/CoreConnect_Bus_Architecture/

Functional Description: Embedded PowerPC 405 Core

This section offers a brief overview of the various functional blocks shown in Figure 16.

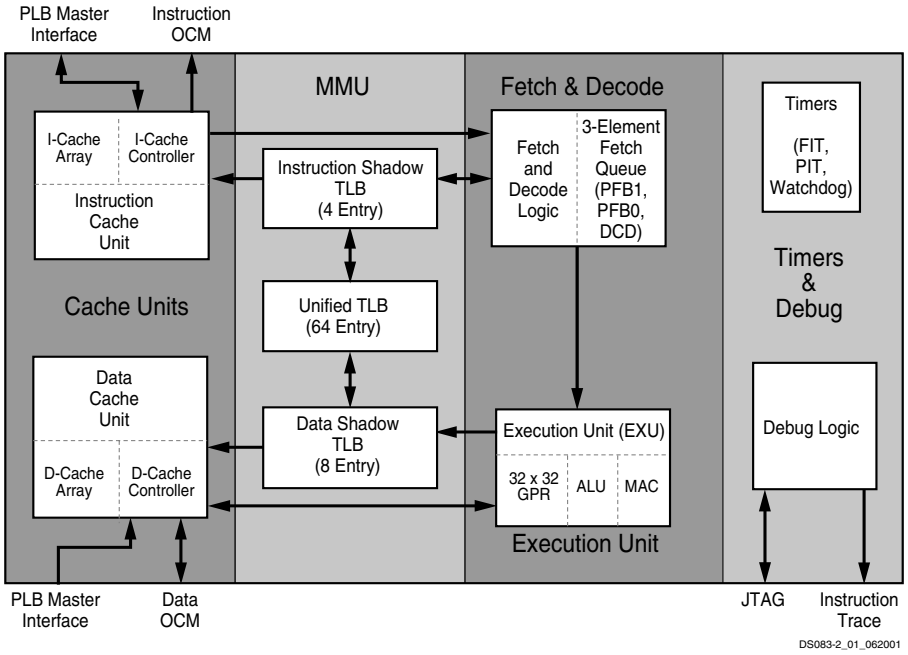

Figure 16: **Embedded PPC405 Core Block Diagram**

Embedded PPC405 Core

The embedded PPC405 core is a 32-bit Harvard architecture processor. Figure 16 illustrates its functional blocks:

- Cache units
- Memory Management unit
- Fetch Decode unit

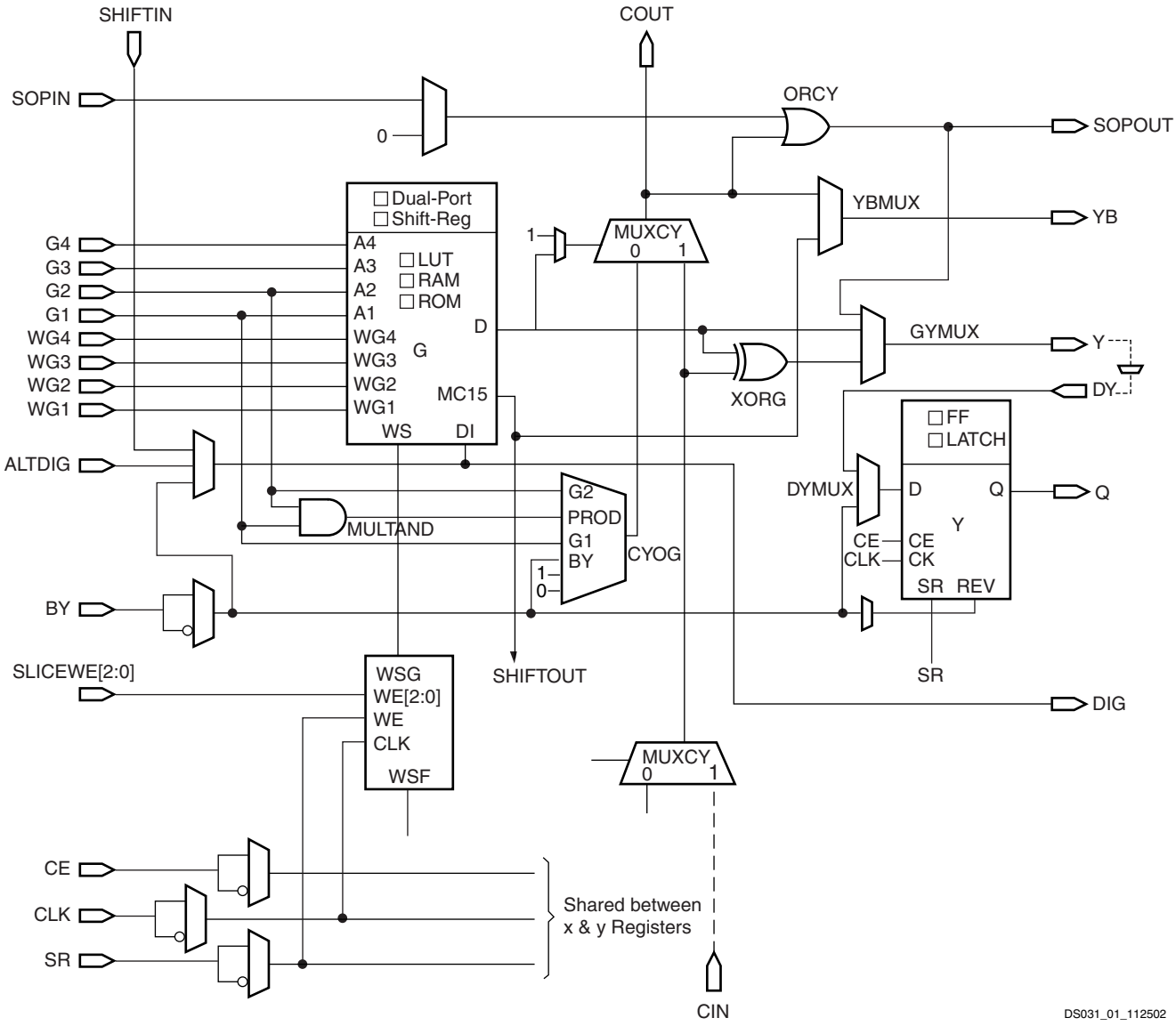

Figure 34: **Virtex-II Pro Slice (Top Half)**

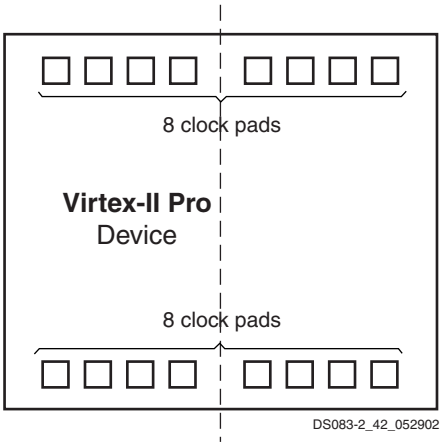

Figure 55: **Virtex-II Pro Clock Pads**

Each global clock multiplexer buffer can be driven either by the clock pad to distribute a clock directly to the device, or by the Digital Clock Manager (DCM), discussed in Digital Clock Manager (DCM), page 51. Each global clock multiplexer buffer can also be driven by local interconnects. The DCM has clock output(s) that can be connected to global clock multiplexer buffer inputs, as shown in Figure 56.

Global clock buffers are used to distribute the clock to some or all synchronous logic elements (such as registers in CLBs and IOBs, and SelectRAM+ blocks.

Eight global clocks can be used in each quadrant of the Virtex-II Pro device. Designers should consider the clock distribution detail of the device prior to pin-locking and floorplanning. (See the *Virtex-II Pro Platform FPGA User Guide*.)

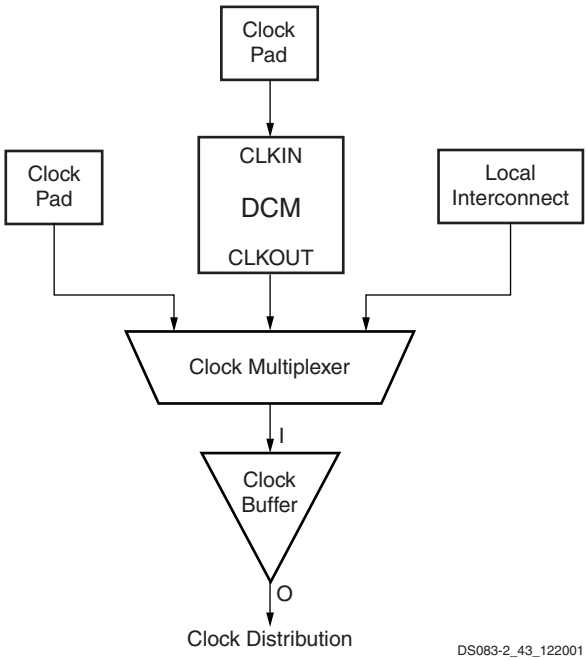

Figure 56: **Virtex-II Pro Clock Multiplexer Buffer Configuration**

Virtex-II Pro Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II Pro devices. The numbers reported here are fully characterized worst-case values. Note that these values are subject to the same guidelines as Virtex-II Pro Switching Characteristics (speed files).

Table 13 provides pin-to-pin values (in nanoseconds) including IOB delays; that is, delay through the device from input pin to output pin. In the case of multiple inputs and outputs, the worst delay is reported.

Table 13: **Pin-to-Pin Performance**

Description	Device Used & Speed Grade	Pin-to-Pin Performance (with I/O Delays)	Units
Basic Functions:			
16-bit Address Decoder	XC2VP20FF1152-6	7.20	ns
32-bit Address Decoder	XC2VP20FF1152-6	8.08	ns
64-bit Address Decoder	XC2VP20FF1152-6	8.15	ns
4:1 MUX	XC2VP20FF1152-6	3.85	ns
8:1 MUX	XC2VP20FF1152-6	7.24	ns
16:1 MUX	XC2VP20FF1152-6	7.30	ns
32:1 MUX	XC2VP20FF1152-6	7.64	ns
Combinatorial (pad to LUT to pad)	XC2VP20FF1152-6	3.26	ns
Memory:			
Block RAM			
Pad to setup	XC2VP20FF1152-6	1.72	ns
Clock to Pad	XC2VP20FF1152-6	6.63	ns
Distributed RAM			
Pad to setup	XC2VP20FF1152-6	1.78	ns
Clock to Pad	XC2VP20FF1152-6	4.12	ns

Virtex-II Pro Switching Characteristics

Switching characteristics are specified on a per-speed-grade basis and can be designated as Advance, Preliminary, or Production. Note that Virtex-II Pro Performance Characteristics are subject to these guidelines, as well. Each designation is defined as follows:

Advance: These speed files are based on simulations only and are typically available soon after device design specifications are frozen. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

Preliminary: These speed files are based on complete ES (engineering sample) silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting delays is greatly reduced as compared to Advance data.

Production: These speed files are released once enough production silicon of a particular device family member has been characterized to provide full correlation between speed files and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device. Table 15 correlates the current status of each Virtex-II Pro device with a corresponding speed file designation.

All specifications are always representative of worst-case supply voltage and junction temperature conditions.

Table 15: **Virtex-II Pro Device Speed Grade Designations**

Device	Speed Grade Designations		
	Advance	Preliminary	Production
XC2VP2			-7, -6, -5
XC2VP4			-7, -6, -5
XC2VP7			-7, -6, -5
XC2VP20			-7, -6, -5
XC2VPX20		-6, -5	
XC2VP30			-7, -6, -5
XC2VP40			-7, -6, -5
XC2VP50			-7, -6, -5
XC2VP70			-7, -6, -5
XC2VPX70		-6, -5	
XC2VP100			-6, -5

Testing of Switching Characteristics

All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotate to the simulation net list. Unless otherwise noted, values apply to all Virtex-II Pro devices.

PowerPC Switching Characteristics

Table 16: **Processor Clocks Absolute AC Characteristics**

Description	Speed Grade						Units
	-7		-6		-5		
	Min	Max	Min	Max	Min	Max	
CPMC405CLOCK frequency	0	400(1)	0	350(1)	0	300	MHz
JTAGC405TCK frequency(2)	0	200	0	175	0	150	MHz
PLBCLK(3)	0	400	0	350	0	300	MHz
BRAMDSOCMCLK(3)	0	400	0	350	0	300	MHz
BRAMISOCMCLK(3)	0	400	0	350	0	300	MHz

Notes:

1. **IMPORTANT!** When CPMC405CLOCK runs at speeds greater than 350 MHz in -7 Commercial grade dual-processor devices, or greater than 300 MHz in -6 Industrial grade dual-processor devices, users must implement the technology presented in **XAPP755**, "PowerPC 405 Clock Macro for -7(C) and -6(I) Speed Grade Dual-Processor Devices." Refer to Table 1, Module 1 to identify dual-processor devices.
2. The theoretical maximum frequency of this clock is one-half the CPMC405CLOCK. However, the achievable maximum is dependent on the system, and will be much less.
3. The theoretical maximum frequency of these clocks is equal to the CPMC405CLOCK. However, the achievable maximum is dependent on the system. Please see ***PowerPC 405 Processor Block Reference Guide*** and **XAPP640** for more information.

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
4	IO_L69P_4/VREF_4	AA12			
4	IO_L74N_4/GCLK3S	U12			
4	IO_L74P_4/GCLK2P	V12			
4	IO_L75N_4/GCLK1S	W12			
4	IO_L75P_4/GCLK0P	Y12			
5	IO_L75N_5/GCLK7S	Y11			
5	IO_L75P_5/GCLK6P	W11			
5	IO_L74N_5/GCLK5S	V11			
5	IO_L74P_5/GCLK4P	U11			
5	IO_L69N_5/VREF_5	AA11			
5	IO_L69P_5	Y10			
5	IO_L67N_5	V10			
5	IO_L67P_5	U10			
5	IO_L09N_5/VREF_5	W10			
5	IO_L09P_5	W9			
5	IO_L07N_5/VREF_5	V9			
5	IO_L07P_5	U9			
5	IO_L06N_5/VRP_5	Y8			
5	IO_L06P_5/VRN_5	W8			
5	IO_L05_5/No_Pair	V8			
5	IO_L03N_5/D4	Y7			
5	IO_L03P_5/D5	W7			
5	IO_L02N_5/D6	V7			
5	IO_L02P_5/D7	V6			
5	IO_L01N_5/RDWR_B	W6			
5	IO_L01P_5/CS_B	W5			
6	IO_L01P_6/VRN_6	AB2			
6	IO_L01N_6/VRP_6	AA1			
6	IO_L02P_6	Y2			
6	IO_L02N_6	Y1			
6	IO_L03P_6	W2			
6	IO_L03N_6/VREF_6	W1			
6	IO_L05P_6	V4			
6	IO_L05N_6	V3			
6	IO_L06P_6	V2			

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	IO_L88N_7/VREF_7	L5			
7	IO_L86P_7	L6			
7	IO_L86N_7	K6			
7	IO_L85P_7	K1			
7	IO_L85N_7	K2			
7	IO_L60P_7	K3	NC		
7	IO_L60N_7	K4	NC		
7	IO_L58P_7	K5	NC		
7	IO_L58N_7/VREF_7	J5	NC		
7	IO_L56P_7	J1	NC		
7	IO_L56N_7	J2	NC		
7	IO_L55P_7	J3	NC		
7	IO_L55N_7	J4	NC		
7	IO_L54P_7	J6	NC		
7	IO_L54N_7	H5	NC		
7	IO_L52P_7	H1	NC		
7	IO_L52N_7/VREF_7	H2	NC		
7	IO_L50P_7	H3	NC		
7	IO_L50N_7	H4	NC		
7	IO_L49P_7	G1	NC		
7	IO_L49N_7	G2	NC		
7	IO_L48P_7	G3	NC		
7	IO_L48N_7	G4	NC		
7	IO_L46P_7	G5	NC		
7	IO_L46N_7/VREF_7	F5	NC		
7	IO_L43P_7	F1	NC		
7	IO_L43N_7	F2	NC		
7	IO_L06P_7	F3			
7	IO_L06N_7	F4			
7	IO_L04P_7	E1			
7	IO_L04N_7/VREF_7	E2			
7	IO_L03P_7	E3			
7	IO_L03N_7	E4			
7	IO_L02P_7	D1			
7	IO_L02N_7	D2			
7	IO_L01P_7/VRN_7	C1			
7	IO_L01N_7/VRP_7	C2			

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
N/A	VTRXPAD6	B9			
N/A	AVCCAUXRX6	B10			
N/A	AVCCAUXTX7	B14			
N/A	VTTXPAD7	B13			
N/A	TXNPAD7	A13			
N/A	TXPPAD7	A14			
N/A	GNDA7	C14			
N/A	RXPPAD7	A15			
N/A	RXNPAD7	A16			
N/A	VTRXPAD7	B15			
N/A	AVCCAUXRX7	B16			
N/A	AVCCAUXTX9	B18	NC	NC	
N/A	VTTXPAD9	B17	NC	NC	
N/A	TXNPAD9	A17	NC	NC	
N/A	TXPPAD9	A18	NC	NC	
N/A	GNDA9	C17	NC	NC	
N/A	RXPPAD9	A19	NC	NC	
N/A	RXNPAD9	A20	NC	NC	
N/A	VTRXPAD9	B19	NC	NC	
N/A	AVCCAUXRX9	B20	NC	NC	
N/A	AVCCAUXRX16	AA20	NC	NC	
N/A	VTRXPAD16	AA19	NC	NC	
N/A	RXNPAD16	AB20	NC	NC	
N/A	RXPPAD16	AB19	NC	NC	
N/A	GNDA16	Y17	NC	NC	
N/A	TXPPAD16	AB18	NC	NC	
N/A	TXNPAD16	AB17	NC	NC	
N/A	VTTXPAD16	AA17	NC	NC	
N/A	AVCCAUXTX16	AA18	NC	NC	
N/A	AVCCAUXRX18	AA16			
N/A	VTRXPAD18	AA15			
N/A	RXNPAD18	AB16			
N/A	RXPPAD18	AB15			
N/A	GNDA18	Y14			
N/A	TXPPAD18	AB14			
N/A	TXNPAD18	AB13			
N/A	VTTXPAD18	AA13			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
3	IO_L48N_3	W1	NC		
3	IO_L48P_3	W2	NC		
3	IO_L47N_3	W3	NC		
3	IO_L47P_3	W4	NC		
3	IO_L46N_3	W5	NC		
3	IO_L46P_3	W6	NC		
3	IO_L45N_3/VREF_3	Y1	NC		
3	IO_L45P_3	AA1	NC		
3	IO_L44N_3	Y3	NC		
3	IO_L44P_3	Y4	NC		
3	IO_L43N_3	Y5	NC		
3	IO_L43P_3	Y6	NC		
3	IO_L42N_3	AA2	NC	NC	NC
3	IO_L42P_3	AA3	NC	NC	NC
3	IO_L41N_3	AA4	NC	NC	NC
3	IO_L41P_3	AA5	NC	NC	NC
3	IO_L39N_3/VREF_3	AB1	NC	NC	NC
3	IO_L39P_3	AB2	NC	NC	NC
3	IO_L06N_3	AB3			
3	IO_L06P_3	AB4			
3	IO_L05N_3	AC1			
3	IO_L05P_3	AC2			
3	IO_L04N_3	AD1			
3	IO_L04P_3	AD2			
3	IO_L03N_3/VREF_3	AE1			
3	IO_L03P_3	AF2			
3	IO_L02N_3	AC3			
3	IO_L02P_3	AD4			
3	IO_L01N_3/VRP_3	AE3			
3	IO_L01P_3/VRN_3	AF3			
4	IO_L01N_4/BUSY/DOUT(1)	AC6			
4	IO_L01P_4/INIT_B	AD6			
4	IO_L02N_4/D0/DIN(1)	AB7			
4	IO_L02P_4/D1	AC7			
4	IO_L03N_4/D2	AA7			
4	IO_L03P_4/D3	AA8			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	VCCO_7	L18			
7	VCCO_7	M18			
7	VCCO_7	N18			
N/A	CCLK	W7			
N/A	PROG_B	D22			
N/A	DONE	AB6			
N/A	M0	AC22			
N/A	M1	W20			
N/A	M2	AB21			
N/A	TCK	G8			
N/A	TDI	H20			
N/A	TDO	H7			
N/A	TMS	F7			
N/A	PWRDWN_B	AC5			
N/A	HSWAP_EN	E21			
N/A	RSVD	D5			
N/A	VBATT	E6			
N/A	DXP	F20			
N/A	DXN	G19			
N/A	AVCCAUXTX7	B11			
N/A	VTTXPAD7	B12			
N/A	TXNPAD7	A12			
N/A	TXPPAD7	A11			
N/A	GNDA7	C11			
N/A	RXPPAD7	A10			
N/A	RXNPAD7	A9			
N/A	VTRXPAD7	B10			
N/A	AVCCAUXRX7	B9			
N/A	AVCCAUXTX9	B6	NC	NC	
N/A	VTTXPAD9	B7	NC	NC	
N/A	TXNPAD9	A7	NC	NC	
N/A	TXPPAD9	A6	NC	NC	
N/A	GNDA9	C5	NC	NC	
N/A	RXPPAD9	A5	NC	NC	
N/A	RXNPAD9	A4	NC	NC	
N/A	VTRXPAD9	B5	NC	NC	

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
0	IO_L53_0/No_Pair		A21	NC		
0	IO_L54N_0		H18	NC		
0	IO_L54P_0		G18	NC		
0	IO_L56N_0		C21	NC		
0	IO_L56P_0		C20	NC		
0	IO_L57N_0		J17	NC		
0	IO_L57P_0/VREF_0		H17	NC		
0	IO_L67N_0		E17			
0	IO_L67P_0		D17			
0	IO_L68N_0		D18			
0	IO_L68P_0		C18			
0	IO_L69N_0		J16			
0	IO_L69P_0/VREF_0		H16			
0	IO_L73N_0		E16			
0	IO_L73P_0		D16			
0	IO_L74N_0/GCLK7P		C16			
0	IO_L74P_0/GCLK6S		B16			
0	IO_L75N_0/GCLK5P	BREFCLKN	G16			
0	IO_L75P_0/GCLK4S	BREFCLKP	F16			
1	IO_L75N_1/GCLK3P		F15			
1	IO_L75P_1/GCLK2S		G15			
1	IO_L74N_1/GCLK1P		B15			
1	IO_L74P_1/GCLK0S		C15			
1	IO_L73N_1		D15			
1	IO_L73P_1		E15			
1	IO_L69N_1/VREF_1		H15			
1	IO_L69P_1		J15			
1	IO_L68N_1		C13			
1	IO_L68P_1		D13			
1	IO_L67N_1		D14			
1	IO_L67P_1		E14			
1	IO_L57N_1/VREF_1		H14	NC		
1	IO_L57P_1		J14	NC		
1	IO_L56N_1		C11	NC		
1	IO_L56P_1		C10	NC		

FF1152 Flip-Chip Fine-Pitch BGA Package

As shown in Table 10, XC2VP20, XC2VP30, XC2VP40, and XC2VP50 Virtex-II Pro devices are available in the FF1152 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the differences shown in the No Connect column. Following this table are the FF1152 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
0	IO_L01N_0/VRP_0	E29				
0	IO_L01P_0/VRN_0	E28				
0	IO_L02N_0	H26				
0	IO_L02P_0	G26				
0	IO_L03N_0	H25				
0	IO_L03P_0/VREF_0	G25				
0	IO_L05_0/No_Pair	J25				
0	IO_L06N_0	K24				
0	IO_L06P_0	J24				
0	IO_L07N_0	F26				
0	IO_L07P_0	E26				
0	IO_L08N_0	D30				
0	IO_L08P_0	D29				
0	IO_L09N_0	K23				
0	IO_L09P_0/VREF_0	J23				
0	IO_L19N_0	F24	NC	NC		
0	IO_L19P_0	E24	NC	NC		
0	IO_L20N_0	D28	NC	NC		
0	IO_L20P_0	C28	NC	NC		
0	IO_L21N_0	H24	NC	NC		
0	IO_L21P_0	G24	NC	NC		
0	IO_L25N_0	G23	NC	NC		
0	IO_L25P_0	F23	NC	NC		
0	IO_L26N_0	E27	NC	NC		
0	IO_L26P_0	D27	NC	NC		
0	IO_L27N_0	K22	NC	NC		
0	IO_L27P_0/VREF_0	J22	NC	NC		
0	IO_L37N_0	H22				
0	IO_L37P_0	G22				
0	IO_L38N_0	D26				
0	IO_L38P_0	C26				
0	IO_L39N_0	K21				
0	IO_L39P_0	J21				
0	IO_L43N_0	F22				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
4	IO_L27P_4/VREF_4	AL10	NC	NC		
4	IO_L37N_4	AE13				
4	IO_L37P_4	AF13				
4	IO_L38N_4	AG13				
4	IO_L38P_4	AH13				
4	IO_L39N_4	AJ11				
4	IO_L39P_4	AK11				
4	IO_L43N_4	AE14				
4	IO_L43P_4	AF14				
4	IO_L44N_4	AJ13				
4	IO_L44P_4	AK13				
4	IO_L45N_4	AL11				
4	IO_L45P_4/VREF_4	AM11				
4	IO_L46N_4	AE15				
4	IO_L46P_4	AF15				
4	IO_L47N_4	AG14				
4	IO_L47P_4	AH14				
4	IO_L48N_4	AL13				
4	IO_L48P_4	AL12				
4	IO_L49N_4	AD16				
4	IO_L49P_4	AE16				
4	IO_L50_4/No_Pair	AJ14				
4	IO_L53_4/No_Pair	AK14				
4	IO_L54N_4	AM14				
4	IO_L54P_4	AM13				
4	IO_L55N_4	AF16				
4	IO_L55P_4	AG16				
4	IO_L56N_4	AH15				
4	IO_L56P_4	AJ15				
4	IO_L57N_4	AL14				
4	IO_L57P_4/VREF_4	AL15				
4	IO_L67N_4	AD17				
4	IO_L67P_4	AE17				
4	IO_L68N_4	AH16				
4	IO_L68P_4	AJ16				
4	IO_L69N_4	AK16				
4	IO_L69P_4/VREF_4	AL16				
4	IO_L73N_4	AF17				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
1	IO_L43P_1	B13		
1	IO_L39N_1	G13		
1	IO_L39P_1	F13		
1	IO_L38N_1	J15		
1	IO_L38P_1	J14		
1	IO_L37N_1	B12		
1	IO_L37P_1	A12		
1	IO_L27N_1/VREF_1	D13		
1	IO_L27P_1	D12		
1	IO_L26N_1	L13		
1	IO_L26P_1	K13		
1	IO_L25N_1	F12		
1	IO_L25P_1	E12		
1	IO_L21N_1	B11		
1	IO_L21P_1	A11		
1	IO_L20N_1	K12		
1	IO_L20P_1	J12		
1	IO_L19N_1	C12		
1	IO_L19P_1	C11		
1	IO_L09N_1/VREF_1	F11		
1	IO_L09P_1	E11		
1	IO_L08N_1	H13		
1	IO_L08P_1	H12		
1	IO_L07N_1	G12		
1	IO_L07P_1	G11		
1	IO_L06N_1	B10		
1	IO_L06P_1	A10		
1	IO_L05_1/No_Pair	G10		
1	IO_L03N_1/VREF_1	D10		
1	IO_L03P_1	C10		
1	IO_L02N_1	K11		
1	IO_L02P_1	J11		
1	IO_L01N_1/VRP_1	F10		
1	IO_L01P_1/VRN_1	E10		
2	IO_L01N_2/VRP_2	B8		
2	IO_L01P_2/VRN_2	B9		
2	IO_L02N_2	C9		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L47P_3	AC10		
3	IO_L46N_3	AE7		
3	IO_L46P_3	AE8		
3	IO_L45N_3/VREF_3	AE5		
3	IO_L45P_3	AE6		
3	IO_L44N_3	AB13		
3	IO_L44P_3	AC13		
3	IO_L43N_3	AE3		
3	IO_L43P_3	AE4		
3	IO_L42N_3	AE1		
3	IO_L42P_3	AE2		
3	IO_L41N_3	AD10		
3	IO_L41P_3	AD11		
3	IO_L40N_3	AF6		
3	IO_L40P_3	AF7		
3	IO_L39N_3/VREF_3	AF4		
3	IO_L39P_3	AF5		
3	IO_L38N_3	AC12		
3	IO_L38P_3	AD12		
3	IO_L37N_3	AF1		
3	IO_L37P_3	AF2		
3	IO_L36N_3	AG6		
3	IO_L36P_3	AG7		
3	IO_L35N_3	AE9		
3	IO_L35P_3	AE10		
3	IO_L34N_3	AF3		
3	IO_L34P_3	AG3		
3	IO_L33N_3/VREF_3	AG1		
3	IO_L33P_3	AG2		
3	IO_L32N_3	AE11		
3	IO_L32P_3	AE12		
3	IO_L31N_3	AH6		
3	IO_L31P_3	AH7		
3	IO_L30N_3	AG5		
3	IO_L30P_3	AH4		
3	IO_L29N_3	AD13		
3	IO_L29P_3	AE13		
3	IO_L28N_3	AH2		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AE19		
N/A	GND		AE18		
N/A	GND		AE17		
N/A	GND		AE9		
N/A	GND		AE6		
N/A	GND		AF25		
N/A	GND		AF24		
N/A	GND		AF23		
N/A	GND		AF22		
N/A	GND		AF21		
N/A	GND		AF20		
N/A	GND		AF19		
N/A	GND		AF18		
N/A	GND		AG42		
N/A	GND		AG1		
N/A	GND		AH39		
N/A	GND		AH36		
N/A	GND		AH7		
N/A	GND		AH4		
N/A	GND		AL42		
N/A	GND		AL1		
N/A	GND		AM22		
N/A	GND		AM21		
N/A	GND		AN39		
N/A	GND		AN4		
N/A	GND		AP34		
N/A	GND		AP9		
N/A	GND		AR42		
N/A	GND		AR35		
N/A	GND		AR22		
N/A	GND		AR21		
N/A	GND		AR8		
N/A	GND		AR1		
N/A	GND		AT36		
N/A	GND		AT7		
N/A	GND		AU37		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	IO_L26P_7	V31	
7	IO_L26N_7	U31	
7	IO_L25P_7	L41	
7	IO_L25N_7	L42	
7	IO_L24P_7	K40	
7	IO_L24N_7	L40	
7	IO_L23P_7	T34	
7	IO_L23N_7	T35	
7	IO_L22P_7	L38	
7	IO_L22N_7/VREF_7	L39	
7	IO_L21P_7	K36	
7	IO_L21N_7	L36	
7	IO_L20P_7	T32	
7	IO_L20N_7	T33	
7	IO_L19P_7	K41	
7	IO_L19N_7	K42	
7	IO_L18P_7	K37	
7	IO_L18N_7	K38	
7	IO_L17P_7	R34	
7	IO_L17N_7	R35	
7	IO_L16P_7	H42	
7	IO_L16N_7/VREF_7	J41	
7	IO_L15P_7	J39	
7	IO_L15N_7	J40	
7	IO_L14P_7	R32	
7	IO_L14N_7	R33	
7	IO_L13P_7	J36	
7	IO_L13N_7	J37	
7	IO_L12P_7	H40	
7	IO_L12N_7	H41	
7	IO_L11P_7	T31	
7	IO_L11N_7	R31	
7	IO_L10P_7	H38	
7	IO_L10N_7/VREF_7	H39	
7	IO_L09P_7	H36	
7	IO_L09N_7	H37	
7	IO_L08P_7	P34	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
N/A	GND	E13	
N/A	GND	A13	
N/A	GND	AD12	
N/A	GND	W12	
N/A	GND	BB9	
N/A	GND	AV9	
N/A	GND	AP9	
N/A	GND	AK9	
N/A	GND	AF9	
N/A	GND	AC9	
N/A	GND	Y9	
N/A	GND	U9	
N/A	GND	N9	
N/A	GND	J9	
N/A	GND	E9	
N/A	GND	A9	
N/A	GND	BB5	
N/A	GND	AV5	
N/A	GND	AP5	
N/A	GND	AK5	
N/A	GND	AF5	
N/A	GND	AC5	
N/A	GND	Y5	
N/A	GND	U5	
N/A	GND	N5	
N/A	GND	J5	
N/A	GND	E5	
N/A	GND	A5	
N/A	GND	BA3	
N/A	GND	B3	
N/A	GND	BA2	
N/A	GND	AY2	
N/A	GND	C2	
N/A	GND	B2	
N/A	GND	AV1	
N/A	GND	AP1	
N/A	GND	AK1	